

ISL85033-12VEVAL3Z

Wide VIN Negative VOUT Buck-Boost Regulator With Up to 5A Output Current

AN1636
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Hardware Description

The ISL85033 is a wide input range, dual standard buck converter that can be configured to provide a negative output voltage. The ISL85033-12VEVAL3Z evaluation board is used in this application note to demonstrate the negative configuration. In this configuration, V_{IN} can range from 4.5V to (28V - V_{OUT}).

The ISL85033 is offered in a 4mmx4mm 28 Ld TQFN package with 1mm maximum height. The complete converter occupies 6.25cm² area.

Key Features

- Wide Input Voltage Range from 4.5V to (28V - V_{OUT})
- Adjustable and Synchronizable Negative Output Voltage with Continuous Output Current up to 5A, depending on V_{OUT} and V_{IN}
- Current Mode Control
- Adjustable Switching Frequency from 300kHz to 2MHz
- Power-Good Detection (referenced to V_{OUT})
- Externally Adjustable Soft-start Time
- Overcurrent and Hiccup Mode Short Circuit Protection, Thermal Overload Protection, UVLO
- Boot Undervoltage Detection
- Default Out-of-phase Channels Reduce Voltage Ripple and Component Size. User-selectable Phase Operation.

Recommended Equipment

The following materials are recommended to perform testing:

- 0V to 30V power supply with at least 7A source current capability or a 5V battery
- Electronic loads capable of sinking current up to 7A
- Digital multimeters (DMMs)
- 100MHz quad-trace oscilloscope
- Signal generator

Quick Setup Guide

1. Ensure that the circuit is correctly connected to the supply and loads prior to applying any power.
2. Connect the bias supply to VIN1, the plus terminal to VIN1, and the negative return to GND1.
3. Verify that the position is ON for S1.
4. Turn on the power supply.
5. Verify the output voltage is -12V for V_{OUT} .

Evaluating the Other Output Voltages

The ISL85033-12VEVAL3Z kit output is preset to -12V; however, output voltages can be adjusted from -3.3V to -15V. The output voltage programming resistor, R3, depends on the desired output voltage of the regulator. The value for the feedback resistor is typically between 0Ω and 142kΩ as shown in Equation 1.

$$R3 = R2 \left(\frac{V_{OUT}}{V_{FB}} - 1 \right) \quad (EQ. 1)$$

Table 1 summarizes the external component selection for $V_{OUT} = -5V$, $V_{OUT} = -12V$, and $V_{OUT} = -15V$.

TABLE 1. COMPONENT SELECTION FOR V_{OUT}

| V_{OUT} | EXTERNAL COMPONENTS |
|-----------|---|
| -5V | R3 = 43.2k; R5 = 20k; C4 = 2.7nF C20 = 22μF (1210 ceramic) C17 = 22μF (1210 ceramic) C19 = 68μF (15mΩ polymer EEFUD0K680R) |
| -12V | R3 = 112k; R5 = 120k; C4 = 4.7nF C14, C17 = 22μF (2210 ceramic) C12, C19 = 68μF (70mΩ TaNbO2 TPSD686M020R0070) C20 = DNP |
| -15V | R3 = 142k; R5 = 120k; C4 = 4.7nF C14, C17 = 22μF (2210 ceramic) C12, C19 = 68μF (70mΩ TaNbO2 TPSD686M020R0070) C20 = DNP |

The curves in Figure 1 indicate the maximum output current the converter can deliver as a function of the input voltage and the selected output voltage configuration.

Figures 2, 3 and 4 show the efficiency for different V_{IN} , V_{OUT} and load combinations.

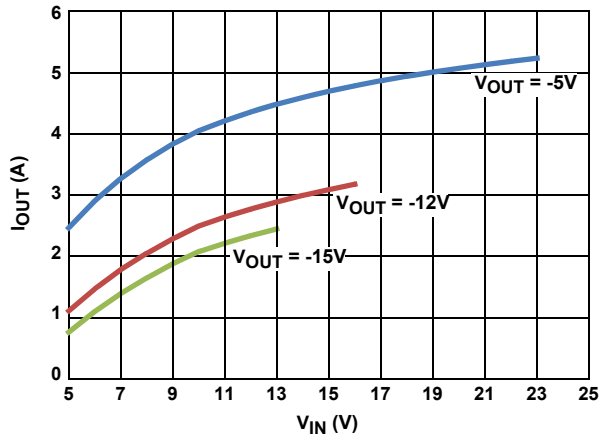


FIGURE 1. ISL85033-12VEVAL3Z BUCK BOOST: RECOMMENDED MAXIMUM I_{OUT} (V_{IN})

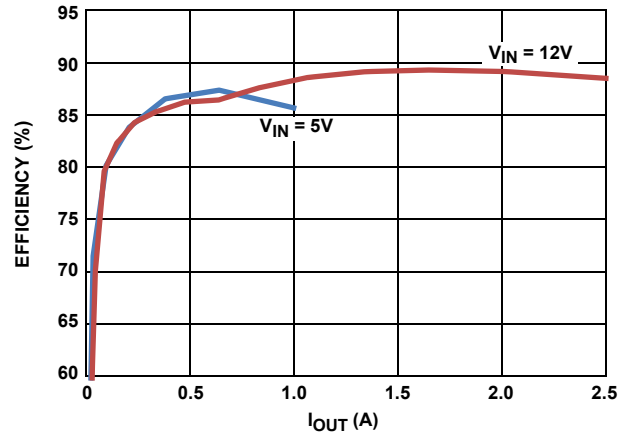


FIGURE 2. ISL85033-12VEVAL3Z EFFICIENCY: $V_{OUT} = -15V$

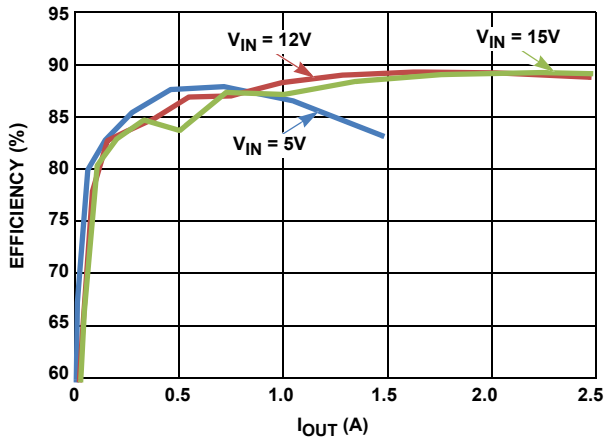


FIGURE 3. ISL85033-12VEVAL3Z EFFICIENCY: $V_{OUT} = -12V$

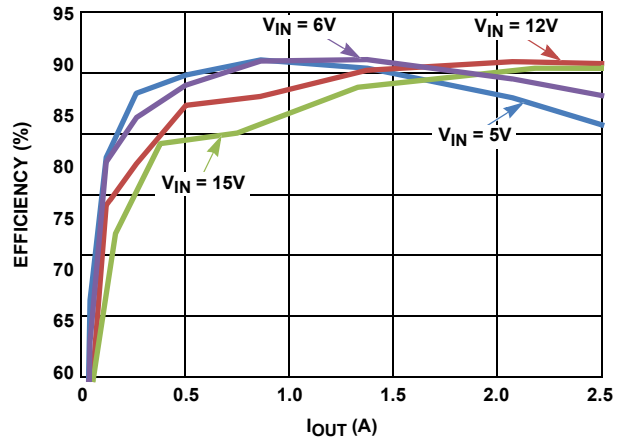


FIGURE 4. ISL85033-12VEVAL3Z EFFICIENCY: $V_{OUT} = -5V$

If the output voltage desired is $-0.8V$, then R3 is shorted. The value for R2 is typically between 1k and 10k. Note that if $V_{OUT} < |2.5V|$ (i.e., $-0.8V$), the switching frequency and compensation must be changed to accommodate the 300kHz operation, due to minimum on-time limitation. Please refer to the [ISL85033](#) data sheet for further information.

Frequency Control

The ISL85033-12VEVAL3Z evaluation board has an FS pin that controls the frequency of operation. Programmable frequency allows for optimization between efficiency and external component size. Default switching frequency is 500kHz when FS is tied to VCC ($R9 = 0$). By removing R9 and connecting R10 to the most negative potential on the board (V_{OUT}), the switching frequency could be changed from 300kHz ($R10 = 383k$) to 2MHz ($R10 = 40.2k$). See the [ISL85033](#) data sheet for information about calculating the value of R10. Do not leave this pin floating.

Disabling/Enabling Function

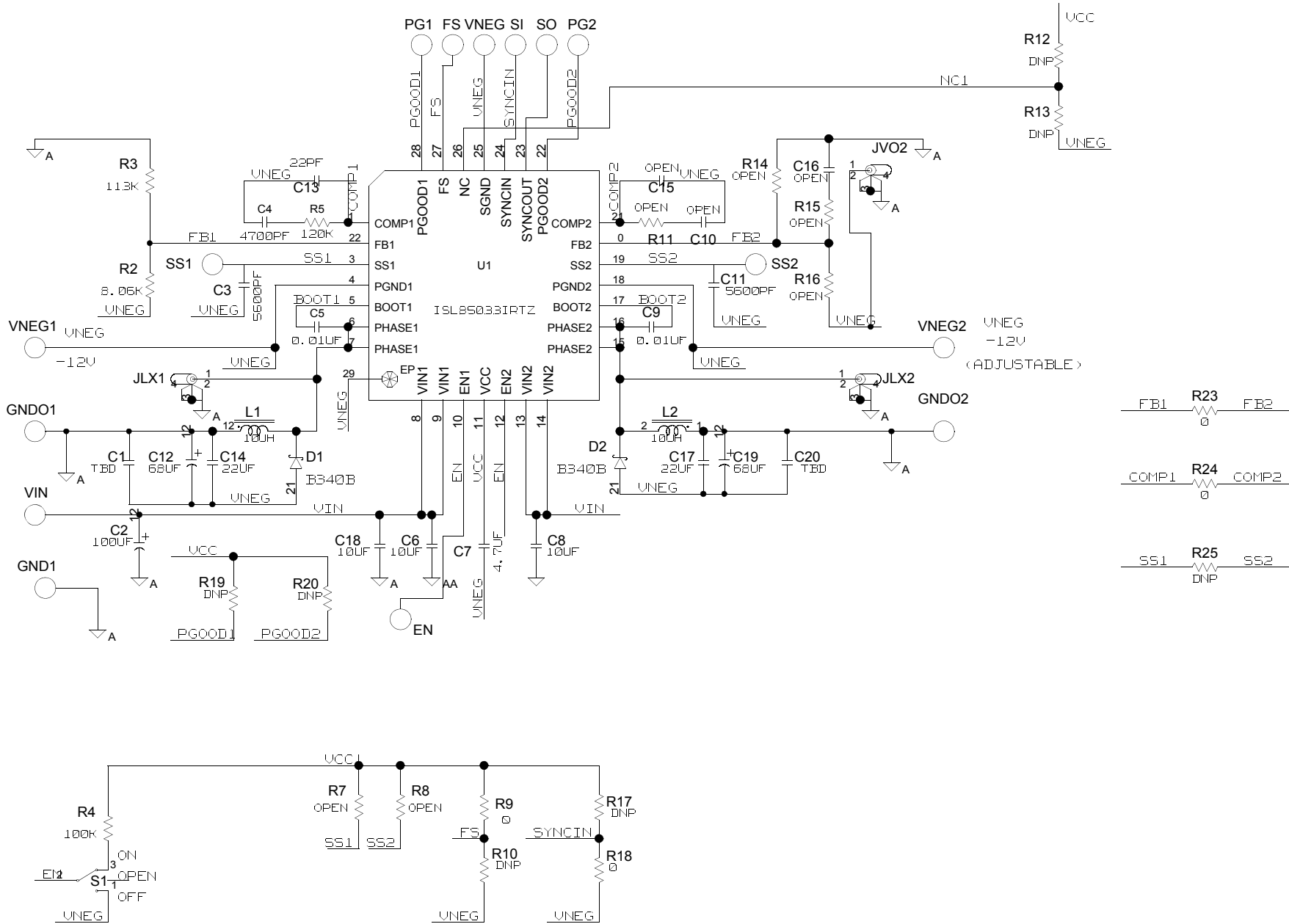
The ISL85033-12VEVAL3Z evaluation board contains an S1 switch that enables or disables both channels, thus allowing a low quiescent current state. Table 2 details this function.

TABLE 2. SWITCH SETTINGS

| S1 | ON/OFF CONTROL |
|-----|-------------------|
| ON | Enable V_{OUT} |
| OFF | Disable V_{OUT} |

NOTE: If driven externally, the EN signal (the same as all input logic signals) is referenced to V_{OUT} (the most negative potential on the board) and not to GND. Therefore, the source cannot be GND referenced, and input level shifting is required.

ISL85033-12VEVAL3Z Schematic



Bill of Materials

| PART NUMBER | REFERENCE DESIGNATOR | QUANTITY | VALUE | TOLERANCE | VOLTAGE | POWER | PACKAGE TYPE | JEDEC TYPE | MANUFACTURER | DESCRIPTION |
|---------------------|--|----------|--------------|-----------|---------|-------|--------------|----------------------|--------------|---|
| 131-4353-00 | JLX1, JLX2, JV02 | 3 | | | | | CONN | TEK131-4353-00 | TEKTRONIX | Scope Probe Test Point PCB Mount |
| TPSD686K020R00070-T | C12, C19 | 2 | 68 μ F | 20% | 20V | | SMD | CAP_TANT | AVX | TQC Series Hi-Volt Low ESR Capacitor |
| B340B | D1, D2 | 2 | | | | | SMD2 | DO_SMA | DIODES | 3A Low VF SCHOTTKY BARRIER RECTIFIER |
| C5750X7R1E226M | C14, C17 | 2 | 22 μ F | 20% | 25V | | 2220 | CAP_2220 | TDK | Ceramic Cap |
| EEE-FK1V101P-T | C2 | 1 | 100 μ F | 20% | 35V | | SMD | CAPAE_315X402 | PANASONIC | AL LYTIC FK SERIES CAP (RoHS COMP.) |
| GMK325BJ106KN | C6, C8 | 2 | 10 μ F | 10% | 35V | | 1210 | CAP_1210 | TAIYO YUDEN | Ceramic Chip Cap |
| GT13MCBE | S1 | 1 | | | | | SW | SW_GT13MCBE | C&K | SPDT On-Off-On Ultraminiature Toggle Switch |
| H1044-00220-50V5 | C13 | 1 | 22PF | 5% | 50V | | 402 | CAP_0402 | GENERIC | Multilayer Cap |
| H1044-00472-50V10 | C4 | 1 | 4700PF | 10% | 50V | | 402 | CAP_0402 | GENERIC | Multilayer Cap |
| H1044-OPEN | C10, C15, C16 | 3 | OPEN | OPEN | OPEN | | 402 | CAP_0402 | GENERIC | Multilayer Cap |
| H1045-00103-50V10 | C5, C9 | 2 | 0.01 μ F | 10% | 50V | | 603 | CAP_0603 | GENERIC | Multilayer Cap |
| H1045-00562-50V10 | C3, C11 | 2 | 5600PF | 10% | 50V | | 603 | CAP_0603 | GENERIC | Multilayer Cap |
| H1046-00475-10V20 | C7 | 1 | 4.7 μ F | 20% | 10V | | 805 | CAP_0805 | GENERIC | Multilayer Cap |
| H1065-00106-25V10-T | C18 | 1 | 10 μ F | 10% | 25V | | SMD | CAP_1206 | VENKEL | Multilayer Cap |
| H1082-TBD-TBD | C1, C20 | 2 | TBD | TBD | TBD | | 1210 | CAP_1210 | GENERIC | Ceramic Chip Cap |
| H2505-01003-1/16WR1 | R4 | 1 | 100k | 0.10% | | 1/16W | 603 | RES_0603 | GENERIC | Metal Film Chip Resistor |
| H2505-DNP-DNP-1 | R10, R17 | 2 | DNP | 1% | | DNP | 603 | RES_0603 | GENERIC | Metal Film Chip Resistor (Do Not Populate) |
| H2505-DNP-DNP-R1 | R12, R13, R19, R20, R25 | 5 | DNP | 0.10% | | DNP | 603 | RES_0603 | GENERIC | Metal Film Chip Resistor (Do Not Populate) |
| H2510-01133-1/16W1 | R3 | 1 | 113k | 1% | | 1/16W | 402 | RES_0402 | GENERIC | Thick Film Chip Resistor |
| H2510-01203-1/16W1 | R5 | 1 | 120k | 1% | | 1/16W | 402 | RES_0402 | GENERIC | Thick Film Chip Resistor |
| H2510-08061-1/16W1 | R2 | 1 | 8.06k | 1% | | 1/16W | 402 | RES_0402 | GENERIC | Thick Film Chip Resistor |
| H2510-ROPEN-OPEN | R7, R8, R11, R14-R16 | 6 | OPEN | 1% | | OPEN | 402 | RES_0402 | GENERIC | Thick Film Chip Resistor |
| H2511-00R00-1/16W | R23, R24 | 2 | 0 | 0% | | 1/16W | 603 | RES_0603 | GENERIC | Thick Film Chip Resistor |
| H2511-00R00-1/16W1 | R9, R18 | 2 | 0 | 1% | | 1/16W | 603 | RES_0603 | GENERIC | Thick Film Chip Resistor |
| ISL85033IRTZ | U1 | 1 | | | | | QFN | QFN28_157X157_157_EP | INTERSIL | WIDE VIN DUAL STANDARD BUCK REGULATOR (Pb-FREE) |
| PAD_100 | EN, FS, SI, SO, PG1, PG2, SS1, SS2, VNEG | 9 | | | | | THOLE | PAD-100 | GENERIC | 0.100 Pad with 0.037 Plated Thru Hole |

Bill of Materials (Continued)

| PART NUMBER | REFERENCE DESIGNATOR | QUANTITY | VALUE | TOLERANCE | VOLTAGE | POWER | PACKAGE TYPE | JEDEC TYPE | MANUFACTURER | DESCRIPTION |
|-------------|---------------------------------------|----------|-------|-----------|---------|-------|--------------|------------|--------------|---------------------------------------|
| PAD_150 | VIN, GND1, GND01, GND02, VNEG1, VNEG2 | 6 | | | | | THOLE | PAD-150 | GENERIC | 0.150 Pad with 0.110 Plated Thru Hole |
| SQ1004 | L1, L2 | 2 | 10µH | 25% | | 4.8A | SMD | IND_SQ10XX | FALCO | SMT SHIELDED POWER INDUCTOR |

ISL85033-12VEVAL3Z Layout

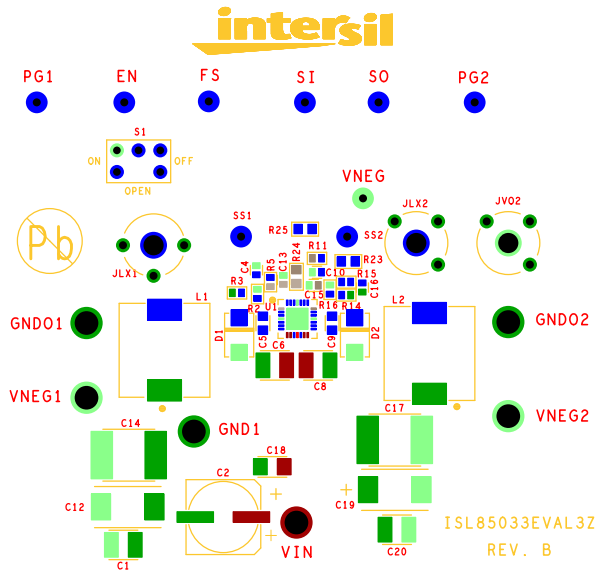


FIGURE 5. TOP LAYER COMPONENTS

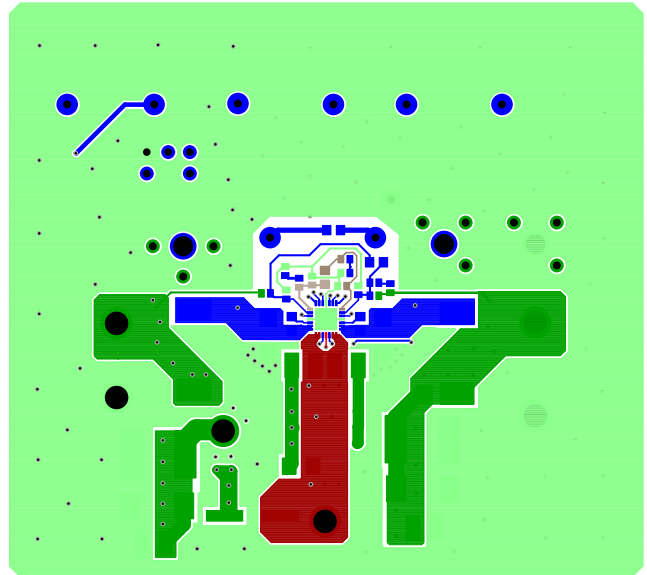


FIGURE 6. TOP LAYER ETCH

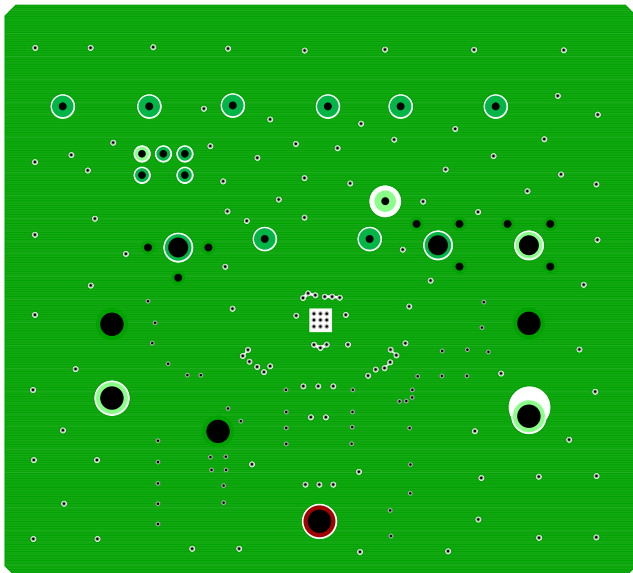


FIGURE 7. SECOND LAYER ETCH

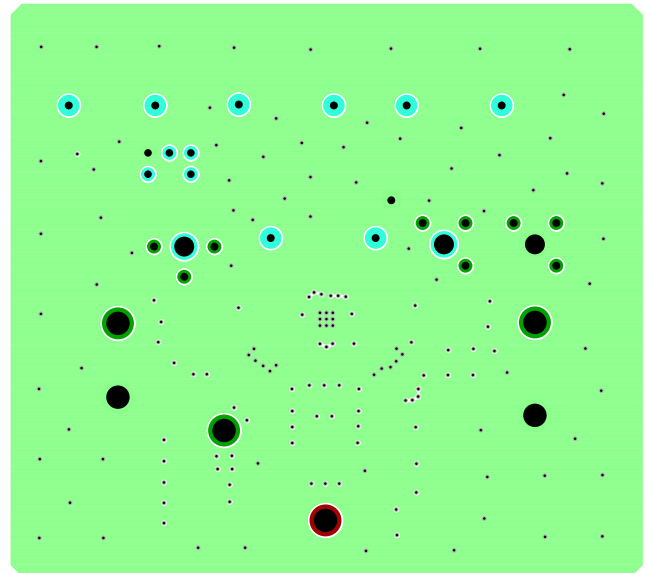


FIGURE 8. THIRD LAYER ETCH

ISL85033-12VEVAL3Z Layout (Continued)

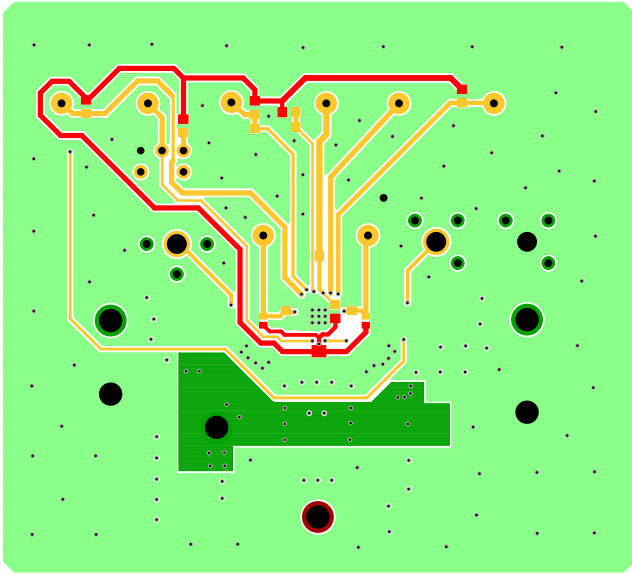


FIGURE 9. BOTTOM LAYER ETCH

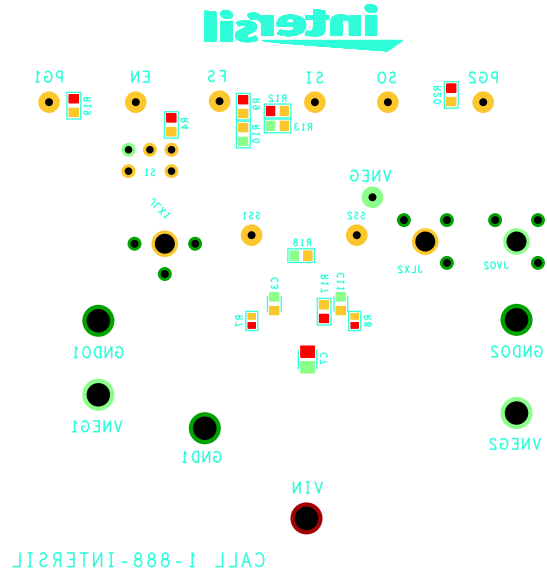


FIGURE 10. BOTTOM LAYER COMPONENTS

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Renesas Electronics America Inc.
1001 Murphy Ranch Road, Milpitas, CA 95035, U.S.A.
Tel: +1-408-432-8888, Fax: +1-408-434-5351

Renesas Electronics Canada Limited
9251 Yonge Street, Suite 8309 Richmond Hill, Ontario Canada L4C 9T3
Tel: +1-905-237-2004

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH
Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
Room 1709 Quantum Plaza, No.27 ZhichunLu, Haidian District, Beijing, 100191 P. R. China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai, 200333 P. R. China
Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited
Unit 1601-1611, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2265-6688, Fax: +852-2886-9022

Renesas Electronics Taiwan Co., Ltd.
13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan
Tel: +886-2-8175-9600, Fax: +886-2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre, Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 1207, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics India Pvt. Ltd.
No.777C, 100 Feet Road, HAL 2nd Stage, Indiranagar, Bangalore 560 038, India
Tel: +91-80-67208700, Fax: +91-80-67208777

Renesas Electronics Korea Co., Ltd.
17F, KAMCO Yangjae Tower, 262, Gangnam-daero, Gangnam-gu, Seoul, 06265 Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5338